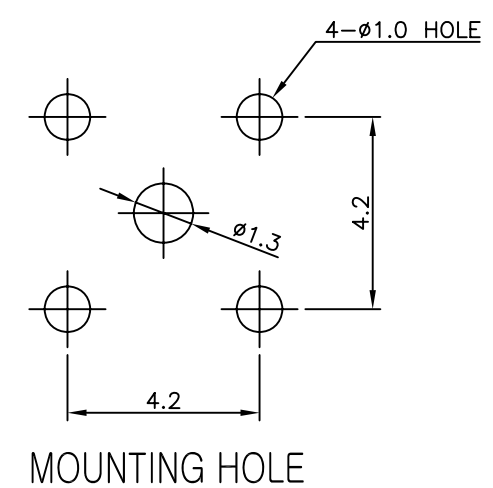
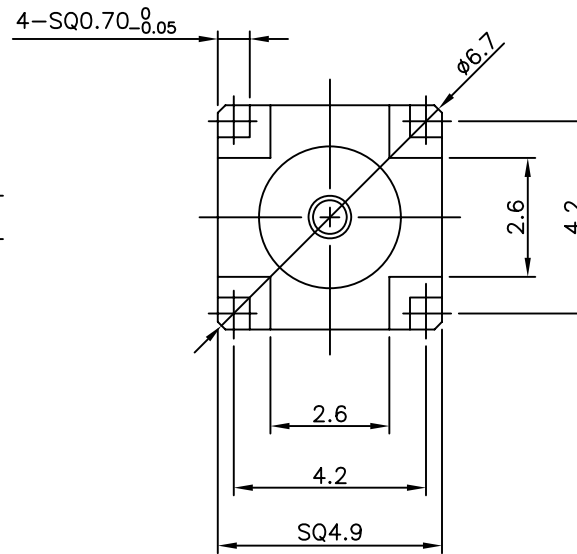
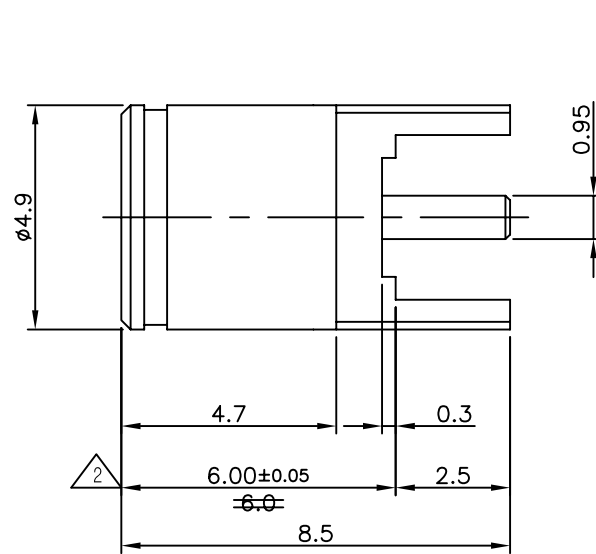
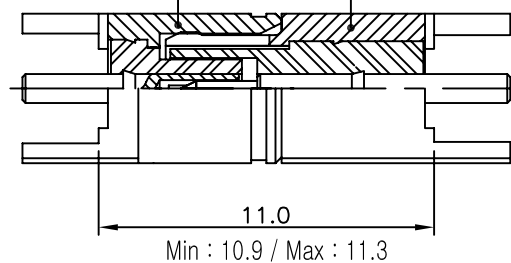


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.05.12.
1	[설변No.202012-0009] 절연체 돌출 방지로 인한 치수 변경	S.Y.EUN	I.C.KIM	2020.12.29.
2	바디 공차변경	S.Y.EUN	I.C.KIM	2021.05.13.



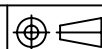
CN03931-7/1
MCXA50 PCB JS-4R

CN03930-7/3
MCXA50 PCB PS-4R



체결도 (SCALE 4:1)

1	3	INSULATOR	1	TEFLON		DIN03142-N/1
2	2	CONTACT	1	BeCu C17300	Gold Plate	DCT04123-5/1
2	1	BODY	1	MBsBD C3604BD-F	Nickel Plate (납땜성향상)	DBD04626-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 12. 29.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle	APPROVED BY I.C.KIM					
		± 0.1				TITLE MCXA50 PCB JS-4R	
MATERIAL	$\pm 1^{\circ}$	CHECKED BY					
		DRAWN BY S.Y.EUN					
FINISH		SCALE 6/1	UNIT mm		DWG NO. CN03931-7/1		
					REVISION 2	SHEET 1 of 1	